











LM95071-Q1

ZHCSJ84 - DECEMBER 2018

LM95071-Q1SPI/MICROWIRE 13 位带符号温度传感器

1 特性

- 符合面向汽车应用的 AEC-Q100 标准
 - 器件温度等级 0: -40°C 至 +150°C, T_A
- 小型 SOT-23 封装节省空间
- 关断模式可在两次读取温度期间节省能量
- 在 -40°C 至 +150°C 整个温度范围内正常工作
- SPI 和 MICROWIRE 总线接口
- 主要规格
 - 电源电压: 2.4V 至 5.5V
 - 电源电流
 - 工作电流: 280µA (典型值)
 - 关断电流: 6µA (典型值)
 - 温度精度
 - 0°C 至 70°C ±1°C (最大值)
 - -40°C 至 150°C ±2°C (最大值)
 - 温度分辨率 0.03125℃

2 应用

- 汽车
- 系统热管理
- 便携式电子设备
- 个人计算机
- 磁盘驱动器
- 办公电子设备
- 电子测试设备

3 说明

LM95071-Q1 是一款低功耗、高分辨率数字温度传感器,具有 SPI 和 MICROWIRE 兼容接口,采用 5 引脚Q1-23 封装。主机可随时查询 LM95071-Q1 以读取温度。它的工作电流低,非常适合低功耗至关重要的系统。

LM95071-Q1 具有 13 位带符号温度分辨率(0.03125° C/LSB),工作温度范围为 −40°C 至 +150°C。

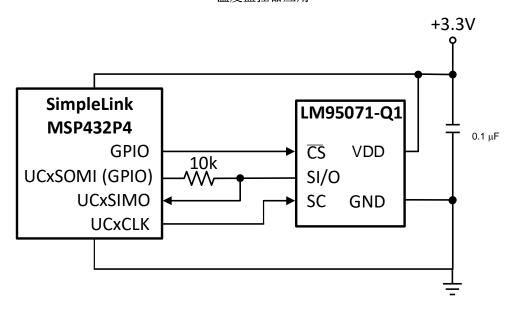
LM95071-Q1 的电源电压范围为 2.4V 至 5.5V,转换速率快、电源电流低以及 SPI 接口简单,因此广泛适用于各种 应用。

器件信息(1)

| 器件型号 | 封装 | 封装尺寸 (标称值) |
|------------|------------|-----------------|
| LM95071-Q1 | SOT-23 (5) | 2.90mm × 1.60mm |

(1) 如需了解所有可用封装,请参阅数据表末尾的可订购产品附录。

温度监控器应用





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4 修订历史记录

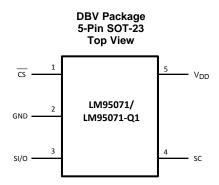
注: 之前版本的页码可能与当前版本有所不同。

| 日期 | 版本 | 注释 |
|-------------|----|---|
| 2018 年 12 月 | * | 初始发行版。将 SNIS137 中的汽车器件移到了单独的数据表中,将 AEC-Q100 资质水平添加到数据表中,将数据表布局更新为最新 SDS 格式,更改了第一页的重要图形,更改了"温度-数字转换器特征"表注以澄清转换间隔,并用热性能信息表替换了热工特性表,以及更新了热阻值 |



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5 Pin Configuration and Functions



Pin Function

| PIN | | DESCRIPTION | | | | |
|-----|-----------------|---|--|--|--|--|
| NO. | NAME | DESCRIPTION | | | | |
| 1 | CS | Chip Select input. This pin receives an active-low signal from the controller to select the device. | | | | |
| 2 | GND | Ground. This is the power and signal ground return. | | | | |
| 3 | SI/O | Serial Input/Output. This serial, bidirectional, data bus pin transmits and receives signals to and from the controller. Schmitt trigger input in the input mode. | | | | |
| 4 | SC | Serial bus clock. This serial clock signal comes from the controller. Schmitt trigger input. | | | | |
| 5 | V _{DD} | Positive Supply Voltage. Supply a DC voltage from 2.4V to 5.5V to this pin and bypass with a 0.1-µF ceramic capacitor to ground. | | | | |

6 Specifications

6.1 Absolute Maximum Ratings (1)(2)(3)

| | MIN | MAX | UNIT |
|---------------------------------------|------|----------------|------|
| Supply voltage | -0.3 | 6 | V |
| Voltage at any pin | -0.3 | $V_{DD} + 0.3$ | ٧ |
| Input current at any pin (4) | | 5 | mA |
| Storage temperature, T _{stg} | -65 | 150 | °C |

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications do not apply when operating the device beyond its rated operating conditions.
- (2) Soldering process must comply with Reflow Temperature Profile specifications. Refer to http://www.ti.com/packaging.
- (3) Reflow temperature profiles are different for lead-free and non-lead-free packages.
- (4) When the input voltage (V_I) at any pin exceeds the power supplies (V_I < GND or V_I > V_{DD}) the current at that pin should be limited to 5 mA.

6.2 ESD Ratings

| | | | VALUE | UNIT | |
|--------------------|-------------------------|---|-------|------|--|
| V | Floatroototic disabores | Human-body model (HBM), per AEC Q100-002 ⁽¹⁾ HBM ESD Classification Level 2 | ±2000 | ., | |
| V _(ESD) | | Charged-device model (CDM), per AEC Q100-011 CDM ESD Classification Level C2 | ±200 | V | |

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.



6.3 Recommended Operating Ratings

| | MIN | MAX | UNIT |
|---|-----|-----|------|
| Specified temperature ⁽¹⁾ , T _{MIN} to T _{MAX} | -40 | 150 | °C |
| Supply voltage (V _{DD}) | 2.4 | 5.5 | V |

(1) The life expectancy of the of the LM95071-Q1 will be reduced when operating at elevated temperatures. of the LM95071-Q1 θ_{JA} (thermal resistance, junction-to-ambient) when attached to a printed-circuit board with 2-oz. foil is summarized in the table below.

6.4 Thermal Information

| | | LM95071-Q1 | |
|------------------------|--|--------------|------|
| | THERMAL METRIC ⁽¹⁾ | DBV (SOT-23) | UNIT |
| | | 5 PINS | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | 167.2 | °C/W |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance | 118.8 | °C/W |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 30.7 | °C/W |
| ΨЈТ | Junction-to-top characterization parameter | 14.4 | °C/W |
| ΨЈВ | Junction-to-board characterization parameter | 30.1 | °C/W |
| R ₀ JC(bot) | Junction-to-case (bottom) thermal resistance | n/a | °C/W |

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

6.5 Temperature-to-Digital Converter Characteristics

Unless otherwise noted, these specifications apply for $V_{DD} = 3.3 \text{ V}$. All limits $T_A = T_J = +25^{\circ}\text{C}$, unless otherwise noted.

| PARAMETER | TES | r conditions | MIN ⁽¹⁾ | TYP ⁽²⁾ | MAX ⁽¹⁾ | UNIT | |
|--|--|---|--------------------|--------------------|--------------------|------------|--|
| ine regulation Resolution Gemperature onversion time | $V_{DD} = 3.0V \text{ to } 3.6V; T_A = 0^{\circ}\text{C to}$ | $c + 70$ °C, $T_A = T_J = T_{MIN}$ to T_{MAX} | | | ±1.0 | °C | |
| remperature error | $V_{DD} = 3.0V \text{ to } 3.6V; T_A = -40^{\circ}C$ | C to +150°C, $T_A = T_J = T_{MIN}$ to T_{MAX} | | | ±2.0 | °C | |
| Line regulation | $V_{DD} = 3.6V \text{ to } 5.5V; T_A = 0^{\circ}\text{C to}$ | | | +0.3 | °C // | | |
| Line regulation | $V_{DD} = 3.0V \text{ to } 2.4V; T_A = 0^{\circ}\text{C to}$ | o +70°C | | | -0.6 | °C/V | |
| Resolution | | | | 14 0.03125 | | Bits °C | |
| Temperature | See ⁽⁴⁾ | $T_A = T_J = +25^{\circ}C$ | | 130 | | | |
| conversion time | See (1) | $T_A = T_J = T_{MIN}$ to T_{MAX} | | | 228 | ms | |
| | On a setting a section of the setting | $T_A = T_J = +25$ °C | | 280 | | | |
| Quiescent current | Operating, serial bus inactive | $T_A = T_J = T_{MIN}$ to T_{MAX} | | | 520 | μΑ | |
| | Chutdour | $T_A = T_J = +25^{\circ}C$ | | 6 | | | |
| | Shutdown | $T_A = T_J = T_{MIN}$ to T_{MAX} | | | 28 | μA | |

- (1) Limits are guaranteed to TI's AOQL (Average Outgoing Quality Level).
- (2) Typicals are at T_A = 25°C and represent most likely parametric norm.
- (3) The of the LM95071-Q1 will operate properly over the V_{DD} supply voltage range of 2.4V to 5.5V.
- (4) Following a power on reset, the user must allow at least 228 ms before making the first read transaction to ensure a first valid temperature read. After the first read, in order to ensure an accurate temperature result, the time interval between any two consecutive temperature reads must be greater than the maximum conversion time of 228 ms.

6.6 Logic Electrical Characteristics - Digital DC Characteristics

Unless otherwise noted, these specifications apply for $V_{DD} = 2.4 \text{ V}$ to 5.5 $V^{(1)}$.

| | PARAMETER | TEST CONDITIONS | MIN ⁽²⁾ | TYP ⁽³⁾ MAX ⁽²⁾ | UNIT |
|--------------------|------------------------------|------------------------------------|-----------------------|---------------------------------------|------|
| V _{IN(1)} | Logical "1" Input Voltage | $T_A = T_J = T_{MIN}$ to T_{MAX} | 0.7 × V _{DD} | V _{DD} + 0.3 | V |
| V _{IN(0)} | Logical "0" Input Voltage | $T_A = T_J = T_{MIN}$ to T_{MAX} | -0.3 | $0.3 \times V_{DD}$ | V |

- The of the LM95071-Q1 will operate properly over the V_{DD} supply voltage range of 2.4V to 5.5V.
- (2) Limits are guaranteed to TI's AOQL (Average Outgoing Quality Level).
- (3) Typicals are at $T_A = 25$ °C and represent most likely parametric norm.

TRUMENTS

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Logic Electrical Characteristics - Digital DC Characteristics (continued)

Unless otherwise noted, these specifications apply for V_{DD} = 2.4 V to 5.5 $V^{(1)}$.

| | PARAMETER | TEST (| CONDITIONS | MIN ⁽²⁾ | TYP ⁽³⁾ | MAX ⁽²⁾ | UNIT |
|----------------------|---|--|--------------------------------------|--------------------|--------------------|--------------------|------|
| | Input Hysteresis | V _{DD} = 3 V to 3.6 V | $T_A = T_J = +25$ °C | | 0.4 | | V |
| | Voltage | V _{DD} = 3 V 10 3.6 V | $T_A = T_J = T_{MIN}$ to T_{MAX} | 0.33 | | | V |
| | Logical "1" Input | $V_{IN} = V_{DD}$ | $T_A = T_J = +25$ °C | | 0.005 | | |
| I _{IN(1)} | Current | VIN = VDD | $T_A = T_J = T_{MIN}$ to T_{MAX} | | | 3 | μA |
| | Logical "0" Input | $V_{IN} = 0 V$ | $T_A = T_J = +25$ °C | | -0.005 | | |
| I _{IN(0)} | Current | VIN = 0 V | $T_A = T_J = T_{MIN}$ to T_{MAX} | -3 | | | μA |
| C _{IN} | All Digital Inputs | $T_A = T_J = +25^{\circ}C$ | | | 20 | | pF |
| V_{OH} | High Level Output Voltage | $I_{OH} = -400 \mu A, T_A = T_J =$ | T _{MIN} to T _{MAX} | 2.25 | | | V |
| V _{OL} | Low Level Output Voltage | $I_{OL} = +1.6 \text{ mA}, T_A = T_J = 0.00$ | T _{MIN} to T _{MAX} | | | 0.4 | V |
| I _{O_TRI} - | TRI-STATE [®] Output Leakage Current | $\begin{aligned} V_O &= GND \\ V_O &= V_{DD}, \ T_A = T_J = T_{MIN} \end{aligned}$ | to T _{MAX} | -1 | | +1 | μΑ |

6.7 Logic Electrical Characteristics - Serial Bus Digital Switching Characteristics

Unless otherwise noted, these specifications apply for V_{DD} = 2.4 V to 5.5 $V^{(1)}$; C_L (load capacitance) on output lines = 100 pF unless otherwise specified.

| | | | MIN ⁽²⁾ | TYP ⁽³⁾ | MAX ⁽²⁾ | UNIT |
|----------------|--|------------------------------------|--------------------|--------------------|--------------------|------|
| | SC (Clock) Period | $T_A = T_J = T_{MIN}$ to T_{MAX} | | | 0.16 | μs |
| t ₁ | SC (Clock) Fellod | $T_A = T_J = +25$ °C | | | DC | |
| t ₂ | CS Low to SC (Clock) High Set-Up Time | $T_A = T_J = T_{MIN}$ to T_{MAX} | 100 | | | ns |
| t ₃ | CS Low to Data Out (SO) Delay | $T_A = T_J = T_{MIN}$ to T_{MAX} | | | 70 | ns |
| t ₄ | SC (Clock) Low to Data Out (SO) Delay | $T_A = T_J = T_{MIN}$ to T_{MAX} | | | 70 | ns |
| t ₅ | CS High to Data Out (SO) TRI-STATE | $T_A = T_J = T_{MIN}$ to T_{MAX} | | | 200 | ns |
| t ₆ | SC (Clock) High to Data In (SI) Hold Time | $T_A = T_J = T_{MIN}$ to T_{MAX} | 50 | | | ns |
| t ₇ | Data In (SI) Set-Up Time to SC (Clock) High | $T_A = T_J = T_{MIN}$ to T_{MAX} | 30 | | | ns |
| t ₈ | SC (Clock) High to CS High Hold Time | $T_A = T_J = T_{MIN}$ to T_{MAX} | 50 | | | ns |

- The of the LM95071-Q1 will operate properly over the V_{DD} supply voltage range of 2.4V to 5.5V.
 Limits are guaranteed to Tl's AOQL (Average Outgoing Quality Level).
 Typicals are at T_A = 25°C and represent most likely parametric norm.

6.8 Timing Diagrams

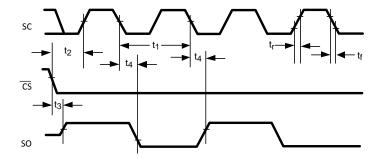


Figure 1. Data Output Timing Diagram



Timing Diagrams (continued)

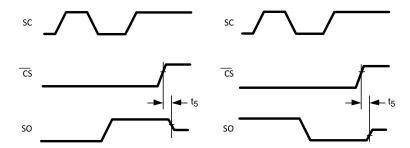


Figure 2. TRI-STATE Data Output Timing Diagram

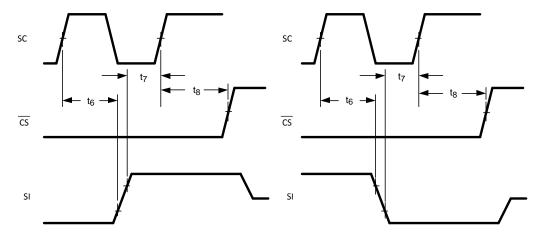
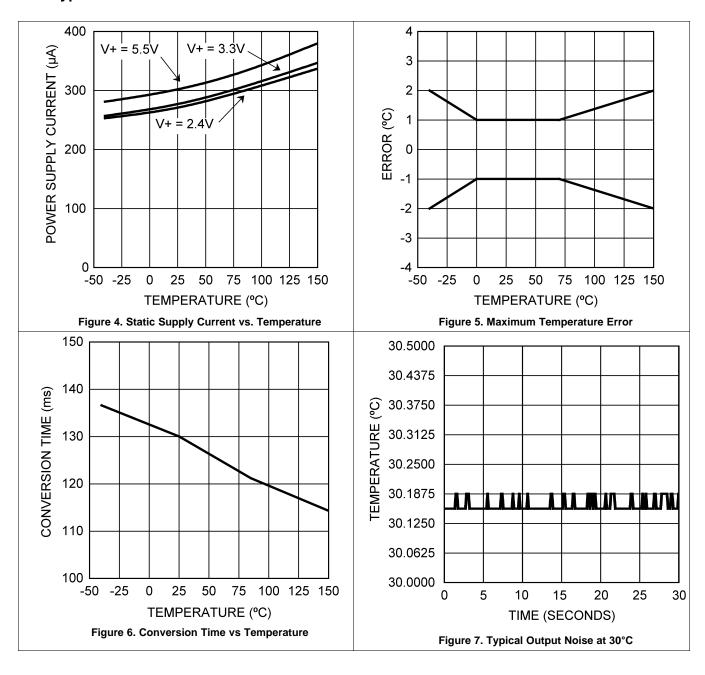


Figure 3. Data Input Timing Diagram

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6.9 Typical Characteristics



7 Parameter Measurement Information

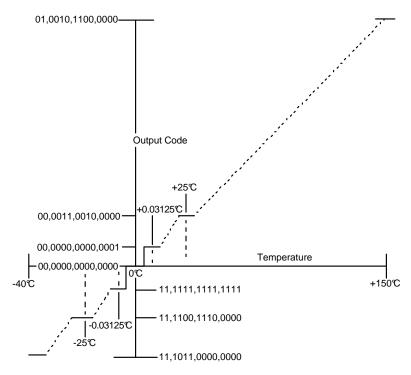


Figure 8. Temperature-to-Digital Transfer Function (Non-Linear Scale for Clarity)

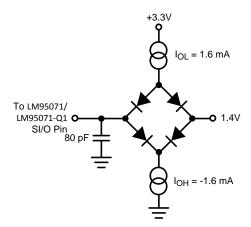


Figure 9. TRI-STATE Test Circuit

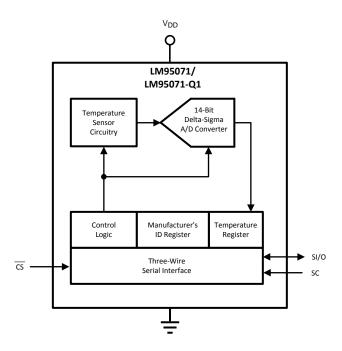
8 Detailed Description

8.1 Overview

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The LM95071-Q1 temperature sensor incorporates a temperature sensor and 13-bit-plus-sign $\Delta\Sigma$ ADC (Delta-Sigma Analog-to-Digital Converter). Compatibility of the LM95071-Q1's three-wire serial interface with SPI and MICROWIRE allows simple communications with common microcontrollers and processors. Shutdown mode can be used to optimize current drain for different applications. A Manufacturer/Device ID register identifies the LM95071-Q1 as a Texas Instruments product.

8.2 Functional Block Diagram



8.3 Feature Description

8.3.1 Power Up and Power Down

The LM95071-Q1 always powers up in a known state and in the continuous conversion mode. Immediately after power up, the LM95071-Q1 will output an erroneous code until the first temperature conversion has completed.

When the supply voltage is less than about 1.6V (typical), the LM95071-Q1 is considered powered down. As the supply voltage rises above the nominal 1.6-V power up threshold, the internal registers are reset to the power up default state described above.

8.3.2 Temperature Data Format

Temperature data is represented by a 14-bit, two's complement word with an LSB (Least Significant Bit) equal to 0.03125°C:

Table 1. Digital Output for Temperature Data

| Tomporatura | Digital Output | | | | | | | | |
|-------------|---------------------|------|--|--|--|--|--|--|--|
| Temperature | Binary | Hex | | | | | | | |
| +150°C | 0100 1011 0000 0011 | 4B03 | | | | | | | |
| +125°C | 0011 1110 1000 0011 | 3E83 | | | | | | | |
| +25°C | 0000 1100 1000 0011 | 0C83 | | | | | | | |
| +0.03125°C | 0000 0000 0000 0111 | 0007 | | | | | | | |
| 0°C | 0000 0000 0000 0011 | 0003 | | | | | | | |

Table 1. Digital Output for Temperature Data (continued)

| Tammaratura | Digital Output | | | | | | | | |
|-------------|---------------------|------|--|--|--|--|--|--|--|
| Temperature | Binary | Hex | | | | | | | |
| -0.03125°C | 1111 1111 1111 1111 | FFFF | | | | | | | |
| -25°C | 1111 0011 1000 0011 | F383 | | | | | | | |
| -40°C | 1110 1100 0000 0011 | EC03 | | | | | | | |

The first data byte is the most significant byte with most significant bit first, permitting only as much data as necessary to be read to determine temperature condition. For instance, if the first four bits of the temperature data indicate an overtemperature condition, the host processor could immediately take action to remedy the excessive temperatures.

8.3.3 Tight Accuracy, Fine Resolution and Low Noise

The LM95071-Q1 is well suited for applications that require tight temperature measurement accuracy. In many applications, from process control to HVAC, the low temperature error can mean better system performance and, by eliminating a system calibration step, lower production cost.

With fine digital resolution, the LM95071-Q1 senses and reports very small changes in its temperature, making it ideal for applications where temperature sensitivity is important. For example, the LM95071-Q1 enables the system to quickly identify the direction of temperature change, allowing the processor to take compensating action before the system reaches a critical temperature.

The LM95071-Q1 has very low output noise (see Figure 7 in the *Typical Characteristics* section), which makes it ideal for applications where stable thermal compensation is a priority. For example, in a temperature-compensated oscillator application, the very small deviation in successive temperature readings translates to a stable frequency output from the oscillator.

8.4 Device Functional Modes

8.4.1 Shutdown Mode/Manufacturer ID

The master controller may enable the shutdown mode for the purpose of reducing power consumption or for reading the Manufacturer/Device ID information. The shutdown mode is enabled by writing XX FF hex to the LM95071-Q1 as shown in Figure 13c. The serial bus is still active when the LM95071-Q1 is in shutdown. When in shutdown mode the LM95071-Q1 always will output 1000 0000 0000 1111. This is the Manufacturer/Device ID information. The first 5-bits of the field (1000 0XXX) are reserved for the manufacturer ID.

8.5 Programming

8.5.1 Serial Bus Interface

The LM95071-Q1 operates as a slave and is compatible with SPI or MICROWIRE bus specifications. Data is clocked out on the falling edge of the serial clock (SC), while data is clocked in on the rising edge of SC. A complete communication is framed by falling and rising chip select (CS) signal. The CS signal should be held high for at least one clock cycle (160 ns minimum) between communications. The transmit-only communication (register read) consists of 16 clock cycles. A complete transmit/receive communication will consist of 32 serial clocks (see Serial Bus Timing Diagrams). The first 16 clocks comprise the transmit phase of communication, while the second 16 clocks are the receive phase.

When \overline{CS} is high SI/O will be in TRI-STATE. Communication should be initiated by taking chip select (\overline{CS}) low. This should not be done when SC is changing from a low to high state. Once \overline{CS} is low the serial I/O pin (SI/O) will transmit the first bit of data. The master can then read this bit with the rising edge of SC. The remainder of the data will be clocked out by the falling edge of SC. \overline{CS} can be taken high at any time during the transmit phase. If \overline{CS} is brought low in the middle of a conversion the LM95071-Q1 will complete the conversion and the output shift register will be updated after \overline{CS} is brought back high.

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Programming (continued)

The receive phase of a communication starts after 16 SC periods. $\overline{\text{CS}}$ can remain low for 32 SC cycles. The LM95071/LM95071-Q1 will read the data available on the SI/O line on the rising edge of the serial clock. Input data is to an 8-bit shift register. The part will detect the last eight bits shifted into the register. The receive phase can last up to 16 SC periods. All ones must be shifted in order to place the part into shutdown. All zeros must be shifted in order to place the LM95071-Q1 into continuous conversion mode. Only the following codes should be transmitted to the LM95071-Q1:

- 00 hex for continuous conversion
- FF hex for shutdown

Another code may place the part into a test mode. Test modes are used by Texas Instruments to thoroughly test the function of the LM95071-Q1 during production testing. Only eight bits have been defined above since only the last eight transmitted are detected by the LM95071-Q1, before CS is taken HIGH.

The following communication can be used to determine the Manufacturer's/Device ID and then immediately place the part into continuous conversion mode. With $\overline{\text{CS}}$ continuously low:

- Read 16 bits of temperature data
- Write 16 bits of data commanding shutdown
- Read 16 bits of Manufacture's/Device ID data
- Write 8 to 16 bits of data commanding Conversion Mode
- Take CS HIGH.

Note that 228 ms (max) will have to pass for a conversion to complete before the LM95071-Q1 actually transmits temperature data.

8.5.2 Serial Bus Timing Diagrams

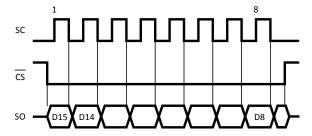


Figure 10. Reading Continuous Conversion - Single Eight-Bit Frame

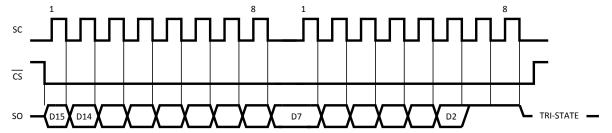


Figure 11. Reading Continuous Conversion - Two Eight-Bit Frames

Programming (continued)

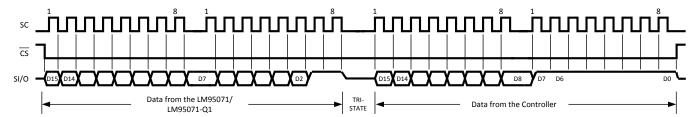


Figure 12. Writing Shutdown Mode

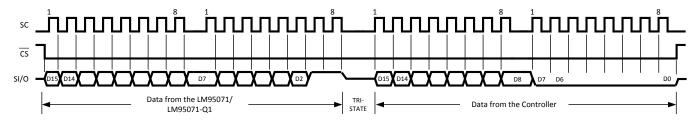


Figure 13. Writing Conversion Mode

8.6 Register Maps

8.6.1 Internal Register Structure

The LM95071-Q1 has three registers: the temperature register, the configuration register and the Manufacturer/Device identification register. The temperature and Manufacturer/Device identification registers are read only. The configuration register is write only.

8.6.1.1 Configuration Register

(Selects shutdown or continuous conversion modes):

Table 2. (Write Only):

| D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----|-----|-----|-----|-----|-----|----|----|----------|----|----|----|----|----|----|----|
| X | Х | X | Х | X | Х | Х | X | Shutdown | | | | | | | |

D0-D15 set to XX FF hex enables shutdown mode.

D0-D15 set to XX 00 hex sets continuous-conversion mode.

Note: setting D0-D15 to any other values may place the LM95071-Q1 into a manufacturer's test mode, upon which the LM95071-Q1 will stop responding as described. These test modes are to be used for Texas Instruments production testing only. See Serial Bus Interface for a complete discussion.

8.6.1.2 Temperature Register

Table 3. (Read Only):

| D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----|--------|--------|--------|-------|-------|-------|-------|-------|-------|-------|-------|------|-----|----|----|
| MSB | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit1 | LSB | 1 | 1 |



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D0-D1: Logic 1 will be output on SI/0.

D2–D15: Temperature Data. One LSB = 0.03125 °C. Two's complement format.

8.6.1.3 Manufacturer/Device ID Register

Table 4. (Read Only):

| D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----|-----|-----|-----|-----|-----|----|----|----|----|----|----|----|----|----|----|
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1 |

D0-D1: Logic 1 will be output on SI/0.

D2-D15: Manufacturer/Device ID Data. This register is accessed whenever the LM95071-Q1 is in shutdown mode.



9 器件和文档支持

9.1 接收文档更新通知

要接收文档更新通知,请导航至 Tl.com.cn 上的器件产品文件夹。单击右上角的通知我进行注册,即可每周接收产品信息更改摘要。有关更改的详细信息,请查阅已修订文档中包含的修订历史记录。

9.2 社区资源

下列链接提供到 TI 社区资源的连接。链接的内容由各个分销商"按照原样"提供。这些内容并不构成 TI 技术规范,并且不一定反映 TI 的观点;请参阅 TI 的 《使用条款》。

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设计支持 TI 参考设计支持 可帮助您快速查找有帮助的 E2E 论坛、设计支持工具以及技术支持的联系信息。

9.3 商标

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9.4 静电放电警告



这些装置包含有限的内置 ESD 保护。 存储或装卸时,应将导线一起截短或将装置放置于导电泡棉中,以防止 MOS 门极遭受静电损伤。

9.5 术语表

SLYZ022 — TI 术语表。

这份术语表列出并解释术语、缩写和定义。

10 机械、封装和可订购信息

以下页面包含机械、封装和可订购信息。这些信息是指定器件的最新可用数据。数据如有变更,恕不另行通知,且不会对此文档进行修订。如需获取此数据表的浏览器版本,请查阅左侧的导航栏。

10-Nov-2025

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PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type | Package Pins | Package qty Carrier | RoHS | Lead finish/ Ball material | MSL rating/ Peak reflow | Op temp (°C) | Part marking (6) |
|-----------------------|---------------|---------------|------------------|-----------------------|------|-------------------------------|----------------------------|--------------|------------------|
| LM95071QIMF/NOPB | Obsolete | Production | SOT-23 (DBV) 5 | - | - | Call TI | Call TI | -40 to 150 | T18Q |
| LM95071QIMFX/NOPB | Active | Production | SOT-23 (DBV) 5 | 3000 LARGE T&R | Yes | SN | Level-1-260C-UNLIM | -40 to 150 | T18Q |
| LM95071QIMFX/NOPB.A | Active | Production | SOT-23 (DBV) 5 | 3000 LARGE T&R | Yes | SN | Level-1-260C-UNLIM | -40 to 150 | T18Q |

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF LM95071-Q1:

Catalog : LM95071

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



PACKAGE OPTION ADDENDUM

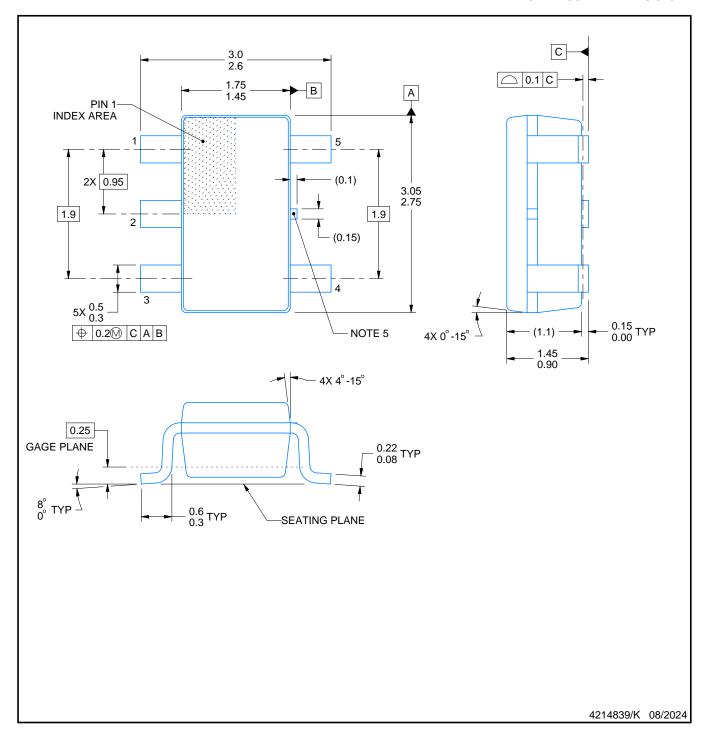
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NOTE: Qualified Version Definitions:

 $_{\bullet}$ Catalog - TI's standard catalog product



SMALL OUTLINE TRANSISTOR



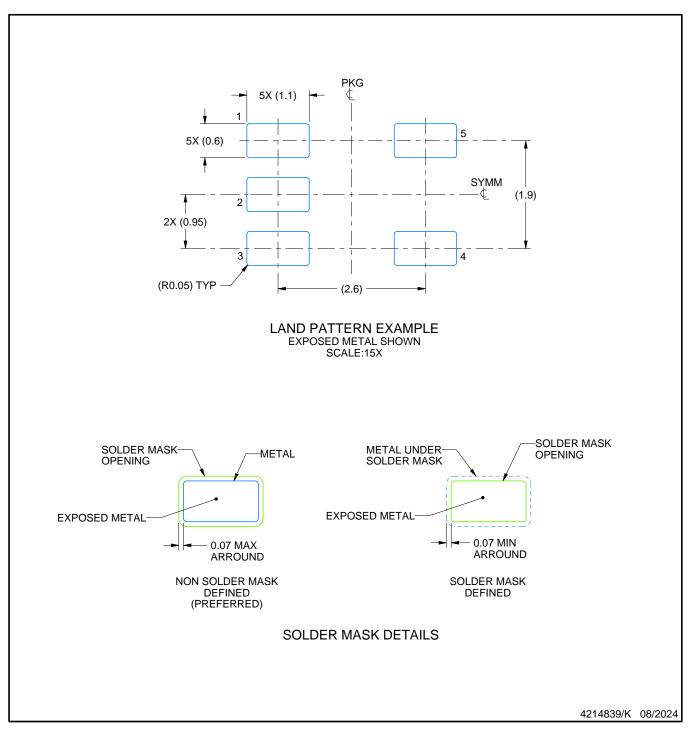
NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 2. This drawing is subject to change without notice.
 3. Reference JEDEC MO-178.

- 4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
- 5. Support pin may differ or may not be present.



SMALL OUTLINE TRANSISTOR



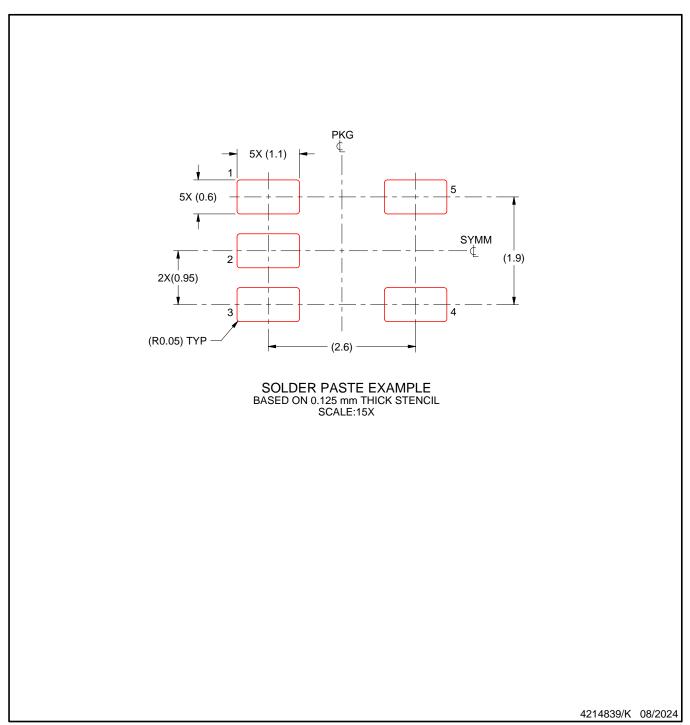
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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